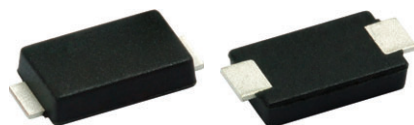


Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

eSMP® Series



Top View

Bottom View

SlimSMA (DO-221AC)

Cathode  Anode

FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	5.0 A
V_{RRM}	50 V
I_{FSM}	100 A
V_F at $I_F = 5.0$ A	0.41 V
T_J max.	150 °C
Package	SlimSMA (DO-221AC)
Circuit configuration	Single

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	VSSAF5N50	UNIT
Device marking code		5N5	
Maximum repetitive peak reverse voltage	V_{RRM}	50	V
Maximum DC forward current (fig. 1)	$I_F^{(1)}$	5.0	A
	$I_F^{(2)}$	3.0	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	100	A
Maximum DC reverse voltage	V_{DC}	35	V
Operating junction and storage temperature range	T_J, T_{STG}	-40 to +150	°C

Notes

(1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 2.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.41	-	V
	I _F = 5.0 A			0.48	0.56	
	I _F = 2.5 A	T _A = 125 °C		0.31	-	
	I _F = 5.0 A			0.41	0.50	
Reverse current	V _R = 35 V	T _A = 25 °C	I _R ⁽²⁾	0.02	-	mA
		T _A = 125 °C		12	-	
	V _R = 50 V	T _A = 25 °C		-	1.4	
		T _A = 125 °C		19	50	
Typical junction capacitance	4.0 V, 1 MHz		C _J	850	-	pF

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)			
PARAMETER	SYMBOL	VSSAF5N50	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	115	$^{\circ}\text{C/W}$
	$R_{\theta JM}^{(1)}$	12	

Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
VSSAF5N50-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel
VSSAF5N50-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel

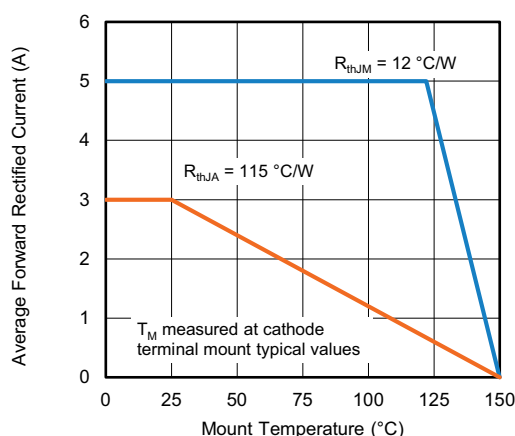
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)


Fig. 1 - Maximum Forward Current Derating Curve

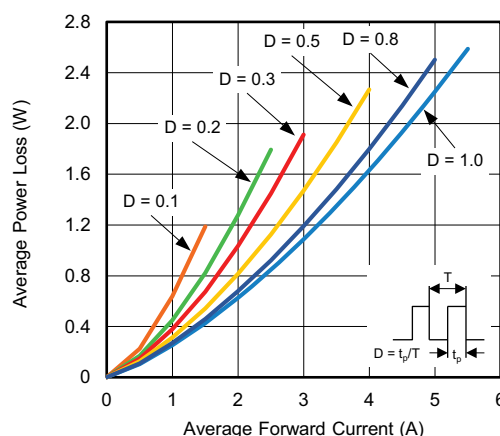


Fig. 2 - Average Power Loss Characteristics

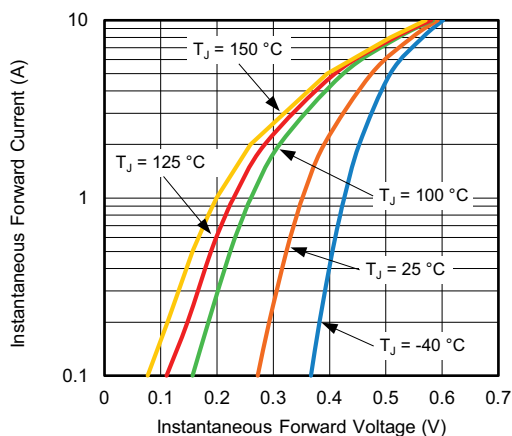


Fig. 3 - Typical Instantaneous Forward Characteristics

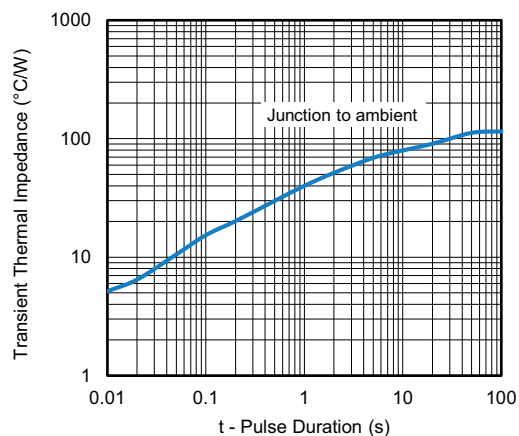


Fig. 6 - Typical Transient Thermal Impedance

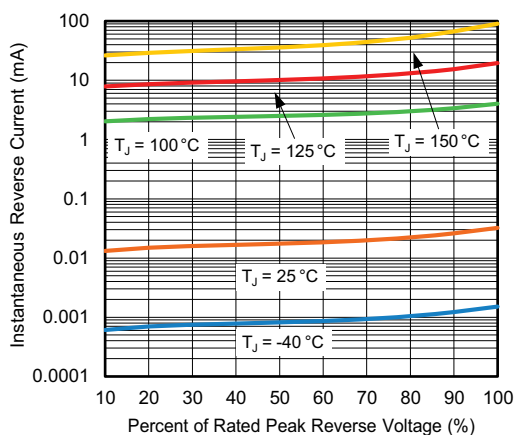


Fig. 4 - Typical Reverse Leakage Characteristics

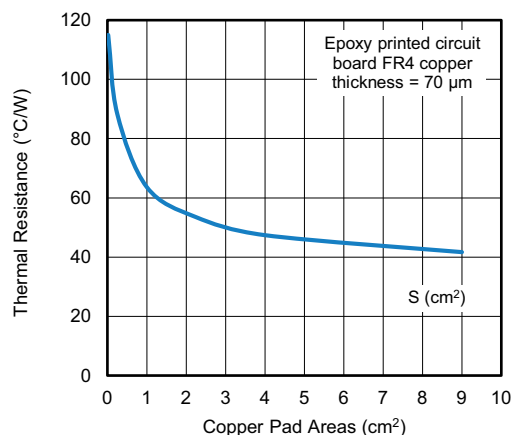


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

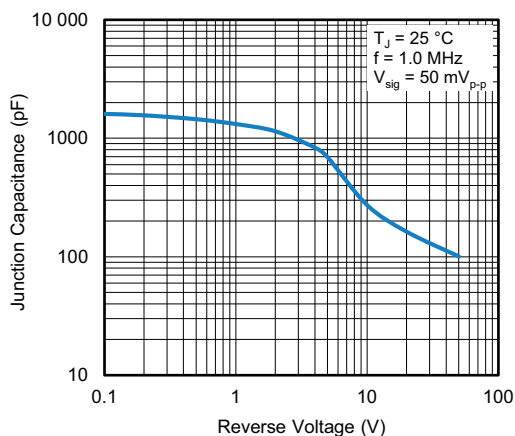
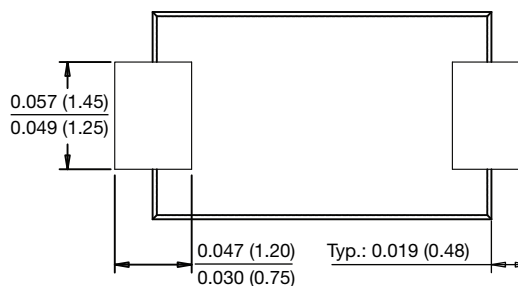
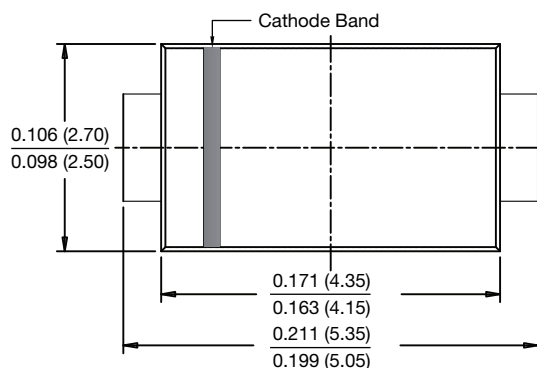


Fig. 5 - Typical Junction Capacitance

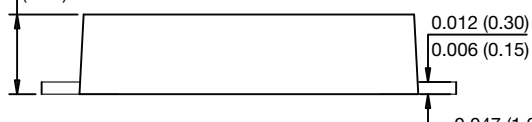


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

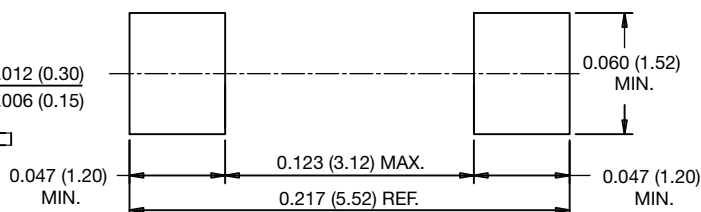
SlimSMA (DO-221AC)



0.039 (1.00)
0.035 (0.90)



Mounting Pad Layout





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